



InGaAs PIN photodiodes

G12183 series

Long wavelength type (cutoff wavelength: 2.55 to 2.6 μm)

Features

- Cutoff wavelength: 2.55 to 2.6 μm
- Low cost
- Photosensitive area: φ0.3 to φ3 mm
- Low noise
- High sensitivity
- High reliability
- → High-speed response
- ➡ High short-wavelength sensitivity (G12183-210KA-03): 0.4 A/W (λ=900 nm)

Applications

- Optical power meters
- **■** Gas analysis
- **→** Moisture meters
- NIR (near infrared) photometry

Options

- → Amplifier for InGaAs PIN photodiode C4159-03
- → Heatsink for two-stage TE-cooled type

 A3179
- → Heatsink for two-stage TE-cooled type A3179-01 (excluding G12183-210KA-03)
- **■** Temperature controller for TE-cooled type C1103-04

Structure

Type no.	Dimensional outline/ Window material*1	Package	Cooling	Photosensitive area (mm)	
G12183-003K				ф0.3	
G12183-005K	(1)/K	TO-18		ф0.5	
G12183-010K			Non-cooled	φ1	
G12183-020K	(2)/K	TO-5		ф2	
G12183-030K	(2)/K	10-5		ф3	
G12183-103K	(3)/K			ф0.3	
G12183-105K		TO-8		ф0.5	
G12183-110K			One-stage TE-cooled	φ1	
G12183-120K				ф2	
G12183-130K				ф3	
G12183-203K				ф0.3	
G12183-205K				ф0.5	
G12183-210K	(4)/K	TO-8	Two-stage TE-cooled	φ1	
G12183-220K				φ2	
G12183-230K				ф3	
G12183-210KA-03	(5)/K	TO-66	Two-stage TE-cooled	ф1	

^{*1:} K=borosilicate glass

The G12183 series may be destroyed or deteriorated by static electricity. Use caution when handling.

♣ Absolute maximum ratings (Ta=25 °C unless otherwise noted)

Type no.	Thermistor power dissipation Pd_th (mW)	Allowable TE-cooler current ITE max (A)	Allowable TE-cooler voltage VTE max (V)	Reverse voltage V _R max (V)	Operating temperature* ² Topr (°C)	Storage temperature* ² Tstg (°C)
G12183-003K						
G12183-005K						
G12183-010K	-	-	-		-40 to +85	-55 to +125
G12183-020K						
G12183-030K						
G12183-103K						
G12183-105K						
G12183-110K		1.5	1.0	1		
G12183-120K						
G12183-130K						
G12183-203K	0.2				-40 to +70*3	-55 to +85
G12183-205K						
G12183-210K		1.0	1.2			
G12183-220K	1	1.0	1.2			
G12183-230K						
G12183-210KA-03				0.5		

^{*2:} No dew condensation

When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

Electrical and optical characteristics (Typ. unless otherwise noted)

Type no.	Chip		(-20/+25 °C)	\ \	Peak sensitivity wavelength	Photosensitivity S λ=λp		Dark current ID VR=0.5 V		Temperature coefficient of dark current VR=0.5 V
	Tchip		B	(um)	λp	Min.	Typ.	Typ.	Max.	
G12183-003K	(°C)	(kΩ)	(K)	(µm)	(µm)	(A/W)	(A/W)	(µA) 0.4	(μA) 4	(times/°C)
	-							1	10	-
G12183-005K								1		-
G12183-010K	25	-	-	0.9 to 2.6				3	30	
G12183-020K								10	100	
G12183-030K								30	300	
G12183-103K								0.12	1.2	
G12183-105K								0.3	3	1
G12183-110K	-10			0.9 to 2.57	2.3	1	1.3	0.9	9	1.035
G12183-120K					2.3	1	1.3	3	30	
G12183-130K								9	90	
G12183-203K		9.0	3300					0.085	0.85	
G12183-205K								0.21	2.1	
G12183-210K	20			0.9 to 2.55				0.65	6.5	
G12183-220K	-20							2.1	21	
G12183-230K								6	60	
G12183-210KA-03								0.05*4	0.1*4	1.067*4

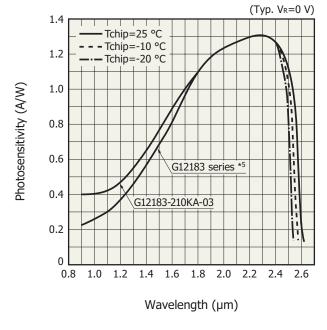
^{*4:} VR=10 mV



^{*3:} Chip temperature and package temperature

Type no.	Measurement conditions Chip temperature	Cutoff frequency fc $V_R=0~V$ RL=50 Ω		Terminal capacitance Ct VR=0 V f=1 MHz		Shunt resistance Rsh VR=10 mV		Detectivity D* λ=λp		Noise equivalent power NEP λ=λp	
	Tchip (°C)	Min. (MHz)	Typ. (MHz)	Typ. (pF)	Max. (pF)	Min. (kΩ)	Typ. (kΩ)	Min. (cm·Hz ^{1/2} /W)	Typ. (cm·Hz ^{1/2} /W)	Typ. (W/Hz ^{1/2})	Max. (W/Hz ^{1/2})
G12183-003K	(c)	20	50	50	100	20	100	(CITTIZ /VV)	(CITTIZ /VV)	4×10^{-13}	9×10^{-13}
G12183-005K	1	5	20	140	300	10	50	3 × 10 ¹⁰	9 × 10 ¹⁰	5 × 10 ⁻¹³	1.5×10^{-12}
G12183-010K	25	2	6	500	1000	2.8	14			1 × 10 ⁻¹²	3 × 10 ⁻¹²
G12183-020K	1	1	1.5	1800	3000	0.65	3			2 × 10 ⁻¹²	5 × 10 ⁻¹²
G12183-030K	1	0.5	0.8	4000	5000	0.25	1.4			3 × 10 ⁻¹²	8 × 10 ⁻¹²
G12183-103K	-10	20	70	44	100	200	1000	1 × 10 ¹¹	3 × 10 ¹¹	1×10^{-13}	3 × 10 ⁻¹³
G12183-105K		5	25	120	300	100	500				4.5×10^{-13}
G12183-110K		2	7	440	1000	28	140			2.5×10^{-13}	
G12183-120K		1	2	1500	3000	6.5	30			5.5×10^{-13}	2×10^{-12}
G12183-130K		0.5	0.9	3400	5000	2.8	14				2.5×10^{-12}
G12183-203K		20	75	40	100	400	2000	1.5 × 10 ¹¹	4.5 × 10 ¹¹	7×10^{-14}	2×10^{-13}
G12183-205K	-20	5	28	110	300	200	1000			1×10^{-13}	3×10^{-13}
G12183-210K		2	8	400	1000	55	280			2×10^{-13}	5.5×10^{-13}
G12183-220K		1	2.3	1400	3000	13	60			4×10^{-13}	1×10^{-12}
G12183-230K		0.5	1	3200	5000	5.5	28			6×10^{-13}	2×10^{-12}
G12183-210KA-03		2	4	500	1000	100	200	2×10^{11}	4×10^{11}	2×10^{-13}	4×10^{-13}

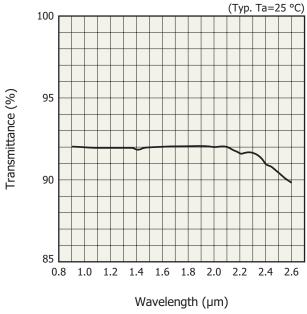
- Spectral response



*5: Excluding G12183-210KA-03

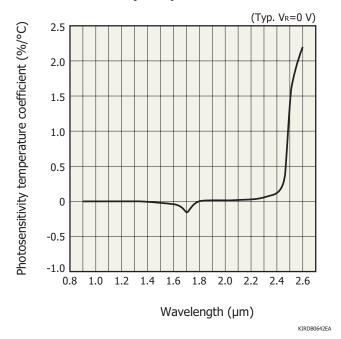
KIRDB0491EE

- Spectral transmittance of window material

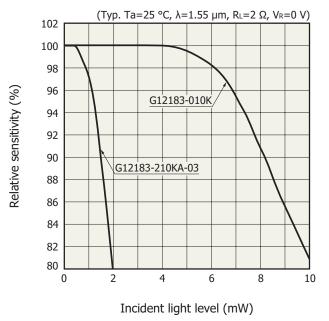


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Photosensitivity temperature characteristics

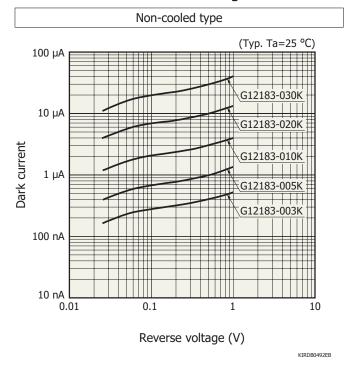


Linearity

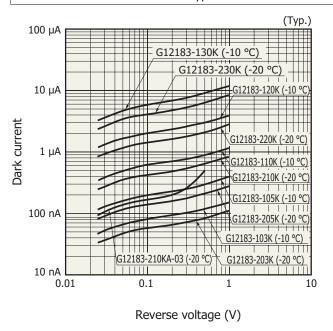


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Dark current vs. reverse voltage



TE-cooled type

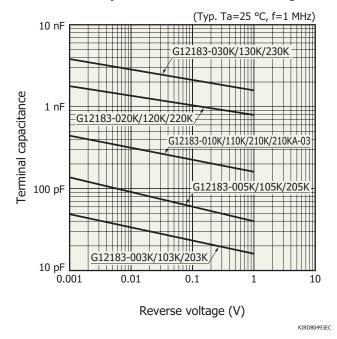


Note: Values in parentheses indicate chip temperature.

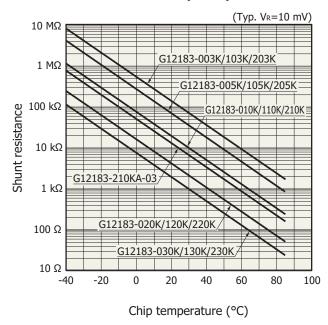
KIRDB0531EC



Terminal capacitance vs. reverse voltage



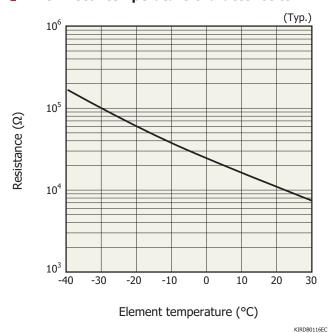
Shunt resistance vs. chip temperature



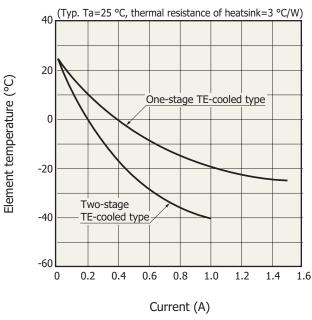
Note: The operating temperature for the one-stage TE-cooled type and two-stage TE-cooled type is up to 70 °C.

KIRDB0494ED

Thermistor temperature characteristics

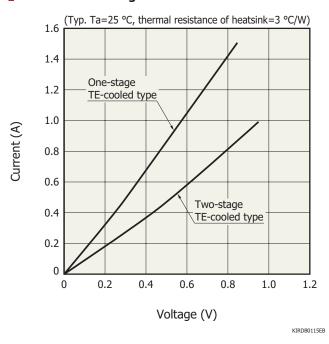


Cooling characteristics of TE-cooler



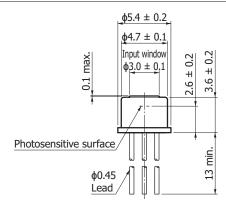
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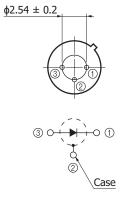
Current vs. voltage characteristics of TE-cooler



Dimensional outlines (unit: mm)

(1) G12183-003K/005K/010K

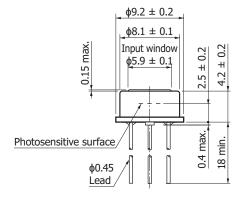


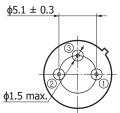


Distance from photosensitive area center to cap center

-0.2≤X≤+0.2 -0.2≤Y≤+0.2

(2) G12183-020K/030K







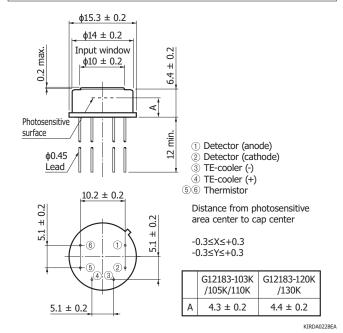
Distance from photosensitive area center to cap center

-0.2≤X≤+0.2 -0.2≤Y≤+0.2

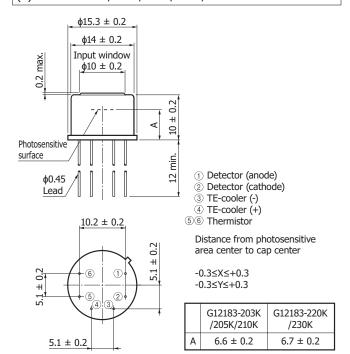


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(3) G12183-103K/105K/110K/120K/130K

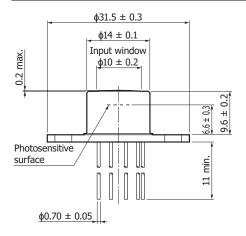


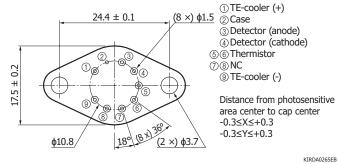
(4) G12183-203K/205K/210K/220K/230K



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(5) G12183-210KA-03





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InGaAs PIN photodiodes

G12183 series

Recommended soldering conditions

Solder temperature: 260 °C (10 s or less, once)

Solder the leads at a point at leat 1 mm away from the package body.

Note: When you set soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- Disclaimer
- · Safety consideration
- · Compound opto-semiconductors (photosensors, light emitters)

Information described in this material is current as of January 2021.

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